LT E6SG

Power TOPLED®

PowerTOPLED, a powerful member of the TOPLED family. Thanks to their high luminous efficacy, the LEDs are ideal for rear light clusters and indicators on vehicles and for display panels for traffic control systems.



Applications

- Cluster, Button Backlighting
- Electronic Equipment

Features:

- Package: white PLCC-4 package, colorless clear silicone resin
- Chip technology: ThinGaN
- Typ. Radiation: 120° (Lambertian emitter)
- Color: $\lambda_{dom} = 530$ nm (• true green)
- Corrosion Robustness Class: 1B
- Qualifications: The product qualification test plan is based on the guidelines of AEC-Q101-REV-C, Stress Test Qualification for Automotive Grade Discrete Semiconductors.
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)



- Interior Illumination (e.g. Ambient Map)



Ordering Information

Туре	Luminous Intensity ¹⁾ I _F = 30 mA I _v	Ordering Code
LT E6SG-BACA-36-U686	1800 3550 mcd	Q65113A4324



Maximum Ratings

Parameter	Symbol		Values	
Operating Temperature	T _{op}	min.	-40 °C	
		max.	110 °C	
Storage Temperature	T _{stg}	min.	-40 °C	
		max.	110 °C	
Junction Temperature ²⁾	T _j	max.	125 °C	
Junction Temperature for short time applications*	T _i	max.	175 °C	
Forward current	I _F	min.	5 mA	
T _s = 25 °C		max.	50 mA	
Surge Current t ≤ 10 µs; D = 0.005 ; T _s = 25 °C	Ι _{FS}	max.	400 mA	
Reverse voltage ³⁾ T _s = 25 °C	V _R	max.	5 V	
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	V_{ESD}		2 kV	

* The median lifetime (L70/B50) for Tj = 175° C is 100h.



Characteristics

 $I_{_{\rm F}}$ = 30 mA; $T_{_{
m S}}$ = 25 °C

Parameter	Symbol		Values	
Peak Wavelength	λ_{peak}	typ.	520 nm	
Dominant Wavelength ⁴⁾ I _F = 30 mA	λ_{dom}	min. typ. max.	516 nm 530 nm 540 nm	
Spectral Bandwidth at 50% I _{rel,max}	Δλ	typ.	33 nm	
Viewing angle at 50% $\rm I_v$	2φ	typ.	120 °	
Forward Voltage ⁵⁾ I _F = 30 mA	V _F	min. typ. max.	2.50 V 2.80 V 3.40 V	
Reverse current ³⁾ $V_R = 5 V$	۱ _R	typ. max.	0.01 μA 10 μA	
Real thermal resistance junction/solderpoint 6)	$R_{thJS real}$	max.	180 K / W	



Brightness Groups

Group	Luminous Intensity ¹⁾ I _F = 30 mA min. I _v	Luminous Intensity. ¹⁾ I _F = 30 mA max. I _v	Luminous Flux ⁷⁾ I _F = 30 mA typ. Φ_v
BA	1800 mcd	2240 mcd	6060 mlm
BB	2240 mcd	2800 mcd	7560 mlm
CA	2800 mcd	3550 mcd	9530 mlm

Forward Voltage Groups

Group Forward Voltage ⁵⁾ $I_F = 30 \text{ mA}$ min. V_F		Forward Voltage ⁵⁾ I _F = 30 mA max. V _F	
U6	2.50 V	2.80 V	
26	2.80 V	3.10 V	
86	3.10 V	3.40 V	

Wavelength Groups

Group	Dominant Wavelength ⁴⁾ I _F = 30 mA min.	Dominant Wavelength ⁴⁾ I _F = 30 mA max.
	λ_{dom}	λ_{dom}
3	516 nm	522 nm
4	522 nm	528 nm
5	528 nm	534 nm
6	534 nm	540 nm



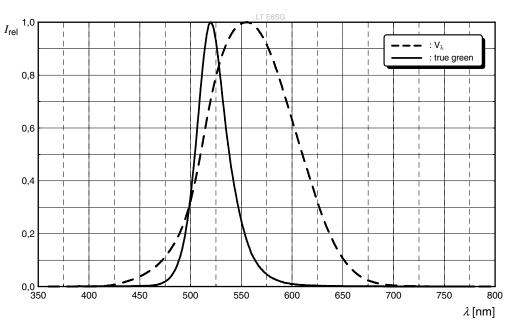
Group Name on Label

Example: BA-3-26		
Brightness	Wavelength	Forward Voltage
BA	3	26



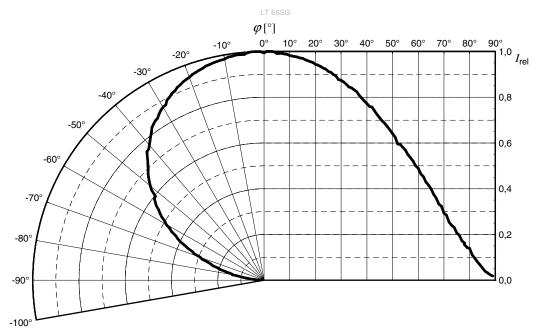
Relative Spectral Emission⁷⁾

 $I_{rel} = f(\lambda); I_{F} = 30 \text{ mA}; T_{S} = 25 \text{ }^{\circ}\text{C}$



Radiation Characteristics ⁷⁾

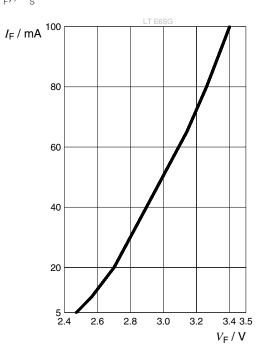
 $I_{rel} = f(\phi); T_{s} = 25 \text{ °C}$





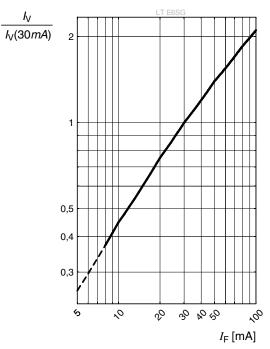
Forward current ⁷

 $I_F = f(V_F); T_S = 25 \ ^{\circ}C$



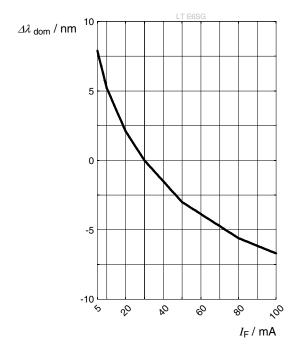
Relative Luminous Intensity 7), 8)

 $I_{v}/I_{v}(30 \text{ mA}) = f(I_{F}); T_{S} = 25 \text{ °C}$

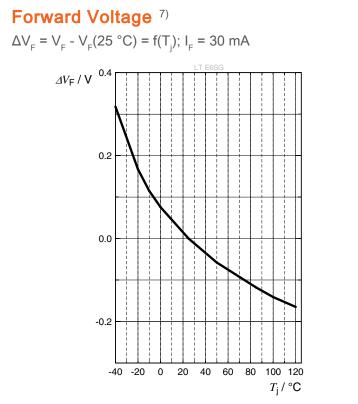


Dominant Wavelength 7)

 $\lambda_{dom} = f(I_F); T_S = 25 \ ^{\circ}C$

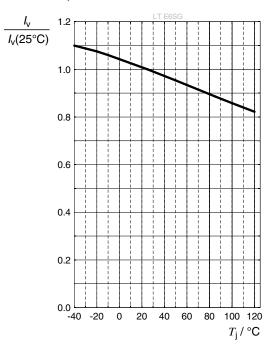






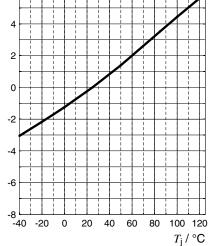
Relative Luminous Intensity ⁷⁾

 $I_{v}/I_{v}(25 \text{ °C}) = f(T_{j}); I_{F} = 30 \text{ mA}$

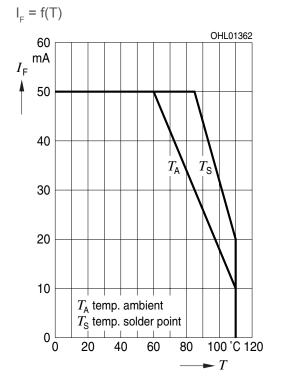


Dominant Wavelength ⁷⁾

 $\lambda_{dom} = f(T_j); I_F = 30 \text{ mA}$

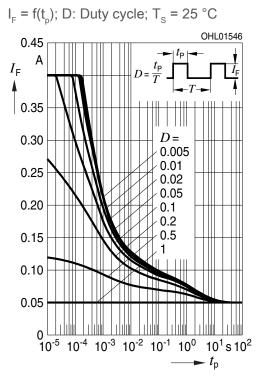






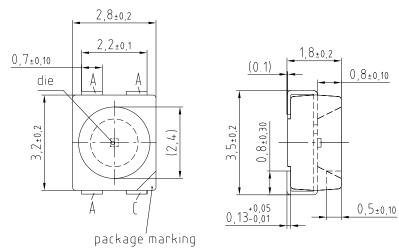
Max. Permissible Forward Current

Permissible Pulse Handling Capability



OSRAM Opto Semiconductors

Dimensional Drawing ⁹⁾



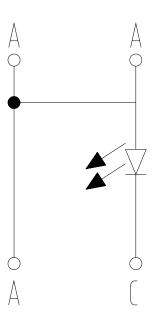
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Further Information:

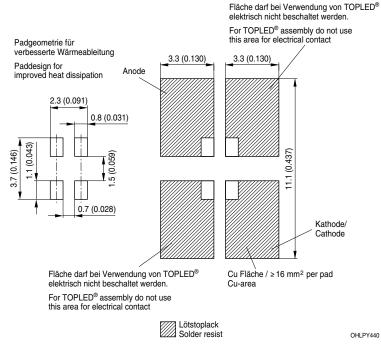
Approximate Weight:	30.0 mg
Package marking:	Cathode
Corrosion test:	Class: 1B Test condition: 25°C / 75 % RH / 200ppb SO ₂ , 200ppb NO ₂ , 10ppb H_2S , 10ppb Cl_2 / 21 days (EN 60068-2-60 (Method 4))



Electrical Internal Circuit



Recommended Solder Pad⁹⁾

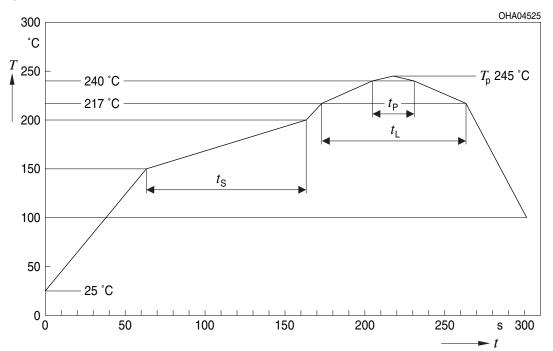


For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.



Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



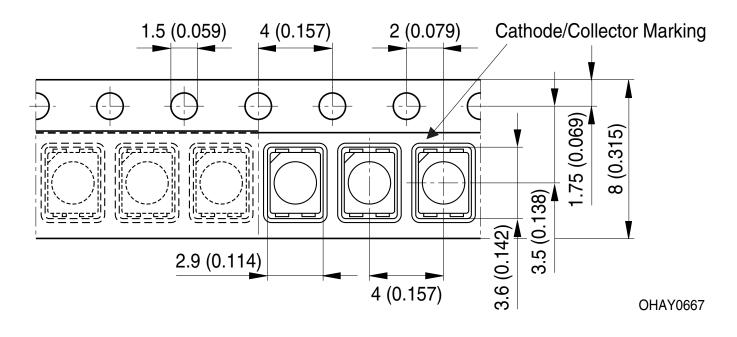
Profile Feature	Symbol Pb-Free (SnAgCu) Assembly				Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat ^{*)} 25 °C to 150 °C			2	3	K/s
Time t _s T _{smin} to T _{smax}	t _s	60	100	120	S
Ramp-up rate to peak ^{*)} $T_{\rm Smax}$ to $T_{\rm P}$			2	3	K/s
Liquidus temperature	TL		217		°C
Time above liquidus temperature	t		80	100	S
Peak temperature	Τ _Ρ		245	260	°C
Time within 5 °C of the specified peak temperature T_P - 5 K	t _P	10	20	30	S
Ramp-down rate* T _P to 100 °C			3	6	K/s
Time 25 °C to T _P				480	S

All temperatures refer to the center of the package, measured on the top of the component

* slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

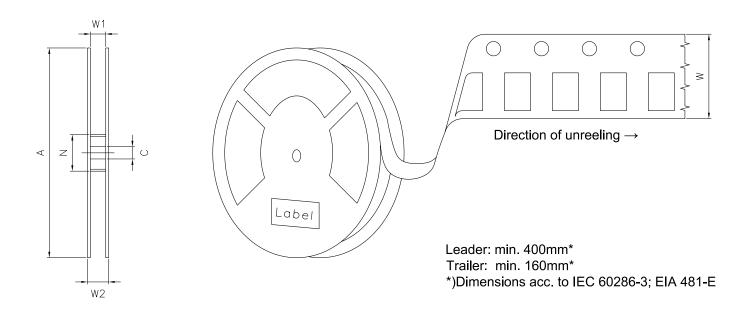


Taping ⁹⁾





Tape and Reel ¹⁰⁾

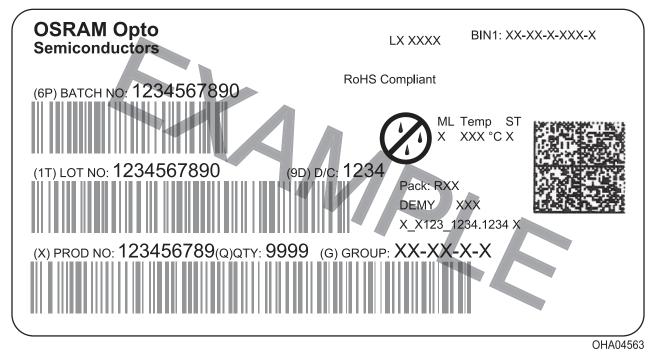


Reel Dimensions

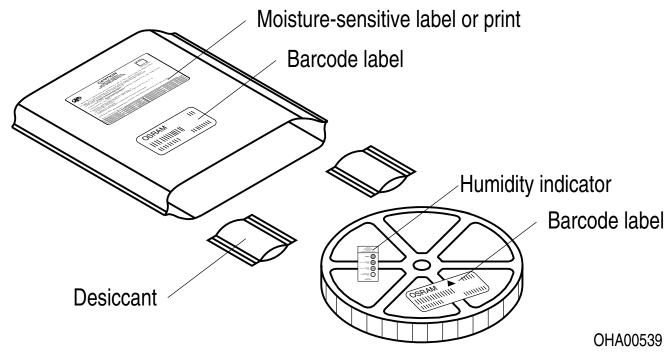
А	W		N _{min}	W_1		$W_{2 \max}$	Pieces per PU
180 mm		8 + 0.3 / - 0.1 mm	60 mm		8.4 + 2 mm	14.4 mm	2000
330 mm		8 + 0.3 / - 0.1 mm	60 mm		8.4 + 2 mm	14.4 mm	8000



Barcode-Product-Label (BPL)



Dry Packing Process and Materials ⁹⁾



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes



Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.



Glossary

- ¹⁾ **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of ± 8 % and an expanded uncertainty of ± 11 % (acc. to GUM with a coverage factor of k = 3).
- ²⁾ **Package discoloration:** The LED chip exhibits excellent performance but slight package discoloration occurs at highest temperatures.
- ³⁾ **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- ⁴⁾ Wavelength: The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of ±0.5 nm and an expanded uncertainty of ±1 nm (acc. to GUM with a coverage factor of k = 3).
- ⁵⁾ **Forward Voltage:** The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of ± 0.05 V and an expanded uncertainty of ± 0.1 V (acc. to GUM with a coverage factor of k = 3).
- ⁶⁾ **Thermal Resistance:** Rth max is based on statistic values (6σ).
- ⁷⁾ Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- ⁸⁾ **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- ⁹⁾ **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- ¹⁰⁾ **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



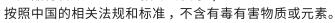
Revision History

Version	Date	Change
1.3	2020-06-17	Features
		Ordering Information
		Maximum Ratings
		Characteristics
		Forward Voltage Groups
		Wavelength Groups
		Electro - Optical Characteristics (Diagrams)
		Further Information
		Electrical Internal Circuit
		Schematic Transportation Box
		Dimensions of Transportation Box
		Glossary
1.4	2022-01-10	Ordering Information
		Brightness Groups



LT E6SG

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